TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

# TC7MH175FK

## Quad D-Type Flip-Flop with Clear

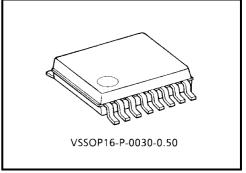
The TC7MH175FK is an advanced high speed CMOS quad D-type flip-flop fabricated with silicon gate  $\rm C^2MOS$  technology.

It achieves the high speed operation similar to equivalent bipolar schottky TTL while maintaining the CMOS low power dissipation.

These four flip-flops are controlled by a clock input (CK) and a clear input ( $\overline{\mathrm{CLR}}$ ).

The information data applied to the D inputs (D1 thru D4) are transferred to the outputs (Q1 thru Q4 and  $\overline{Q}1$  thru  $\overline{Q}4$ ) on the positive-going edge of the clock pulse.

When the  $\overline{\rm CLR}$  input is held low , the Q outputs are at the low logic level and the  $\overline{\rm Q}$  outputs are at the high logic level, regardless of other input conditions.



Weight: 0.02 g (typ.)

An input protection circuit ensures that 0 to 7 V can be applied

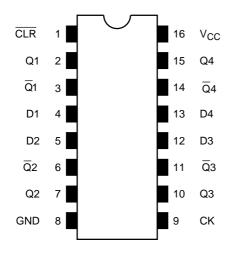
to the input pins without regard to the supply voltage. This device can be used to interface 5 V to 3 V systems and two supply systems such as battery back up. This circuit prevents device destruction due to mismatched supply and input voltages.

#### Features

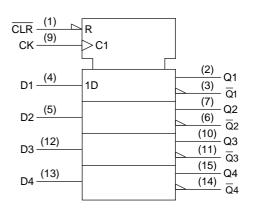
- High speed:  $f_{max} = 210 \text{ MHz} (typ.) (V_{CC} = 5 \text{ V})$
- Low power dissipation:  $I_{CC} = 4 \mu A (max) (Ta = 25^{\circ}C)$
- High noise immunity: V<sub>NIH</sub> = V<sub>NIL</sub> = 28% V<sub>CC</sub> (min)
- Power down protection is provided on all inputs.
- Balanced propagation delays:  $t_{pLH} \approx t_{pHL}$
- Wide operating voltage range:  $V_{CC}$  (opr) = 2~5.5 V
- Low noise: VOLP = 0.8 V (max)
- Pin and function compatible with 74ALS175

## <u>TOSHIBA</u>

## Pin Assignment (top view)



## **IEC Logic Symbol**

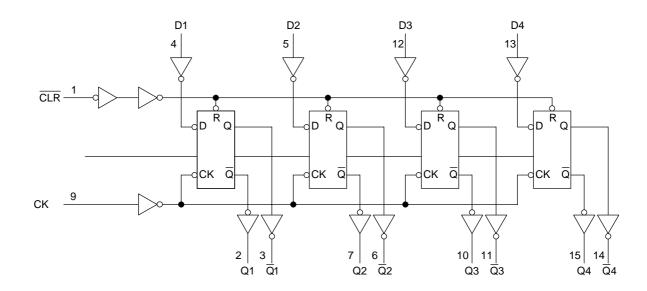


## **Truth Table**

	Inputs		Out	puts	Function	
	D	СК	Q Q			
L	Х	Х	L	Н	Clear	
Н	L		L	Н	—	
н	н		н	L	_	
Н	Х	┍╼┙	Q <sub>n</sub>	$\overline{Q}_{n}$	No change	

X: Don't care

## System Diagram



## **Maximum Ratings**

Characteristics	Symbol	Rating	Unit
Supply voltage range	V <sub>CC</sub>	-0.5~7.0	V
DC input voltage	V <sub>IN</sub>	-0.5~7.0	V
DC output voltage	V <sub>OUT</sub>	$-0.5 \sim V_{CC} + 0.5$	V
Input diode current	I <sub>IK</sub>	-20	mA
Output diode current	IOK	±20	mA
DC output current	IOUT	±25	mA
DC V <sub>CC</sub> /ground current	ICC	±50	mA
Power dissipation	PD	180	mW
Storage temperature	T <sub>stg</sub>	-65~150	°C

## **Recommended Operating Conditions**

Characteristics	Symbol	Rating	Unit
Supply voltage	V <sub>CC</sub>	2.0~5.5	V
Input voltage	V <sub>IN</sub>	0~5.5	V
Output voltage	V <sub>OUT</sub>	0~V <sub>CC</sub>	V
Operating temperature	T <sub>opr</sub>	-40~85	°C
Input rise and fall time	dt/dv	0~100 (V_{CC} = 3.3 $\pm$ 0.3 V)	ns/V
	ui/uv	0~20 (V_{CC} = 5 $\pm$ 0.5 V)	115/ V

## **Electrical Characteristics**

## **DC Characteristics**

Characteristics		Sumbol	Symbol Test Condition			Ta = 25°C			Ta = -40~85°C		Unit
		Symbol			$V_{CC}(V)$	Min	Тур.	Max	Min	Max	Offic
			_		2.0	1.50	_	_	1.50	_	V
Input voltage	High level	VIH			3.0~5.5	$V_{CC} \times 0.7$			$\begin{array}{c} V_{CC} \\ \times \ 0.7 \end{array}$	_	
mput voltage					2.0			0.50		0.50	v
	Low level	VIL		—				$V_{CC} \times 0.3$	_	$\begin{array}{c} V_{CC} \\ \times \ 0.3 \end{array}$	
	High level	V <sub>ОН</sub>	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	I <sub>OH</sub> = -50 μA	2.0	1.9	2.0	_	1.9		
					3.0	2.9	3.0	_	2.9	_	
					4.5	4.4	4.5	_	4.4	_	
				$I_{OH} = -4 \text{ mA}$	3.0	2.58			2.48		
Output voltage				$I_{OH} = -8 \text{ mA}$	4.5	3.94			3.80	_	V
Oulput voltage		V <sub>OL</sub>			2.0		0	0.1		0.1	·
				$I_{OL} = 50 \ \mu A$	3.0		0	0.1		0.1	
	Low level		V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>		4.5		0	0.1		0.1	
				$I_{OL} = 4 \text{ mA}$	3.0	_		0.36		0.44	
				$I_{OL} = 8 \text{ mA}$	4.5	—		0.36		0.44	
Input leakage cu	Input leakage current		$V_{IN} = 5.5 \text{ V or GND}$		0~5.5		_	±0.1		±1.0	μA
Quiescent suppl	y current	Icc	$V_{IN} = V_{CC}$	; or GND	5.5	_	_	4.0		40.0	μA

## Timing Requirements (Input: $t_r = t_f = 3 \text{ ns}$ )

Characteristics	Symbol	Test Condition		Ta = 25°C		Ta = -40~85°C	Unit	
Characteristics	Symbol	Test Condition	V <sub>CC</sub> (V)	Тур.	Limit	Limit	Onit	
Minimum pulse width	t <sub>w (L)</sub>		$\textbf{3.3}\pm\textbf{0.3}$	_	5.0	5.0	ns	
(CK)	t <sub>w (H)</sub>		$5.0\pm0.5$	—	5.0	5.0	115	
Minimum pulse width	<b>t</b> (1)		$\textbf{3.3}\pm\textbf{0.3}$	_	5.0	5.0	ns	
( CLR )	t <sub>w (L)</sub>	_	$5.0\pm0.5$	_	5.0	5.0	115	
Minimum set-up time	ts		$\textbf{3.3}\pm\textbf{0.3}$	_	5.0	5.0	ns	
Minimum set-up time			$5.0\pm0.5$	_	4.0	4.0	115	
Minimum hold time	t <sub>h</sub>		$\textbf{3.3}\pm\textbf{0.3}$	_	1.0	1.0	ns	
			$5.0\pm0.5$	—	1.0	1.0	115	
Minimum removal time	+		$\textbf{3.3}\pm\textbf{0.3}$	—	5.0	5.0	ns	
( CLR )	t <sub>rem</sub>		$5.0\pm0.5$		5.0	5.0	113	

#### AC Characteristics (Input: $t_r = t_f = 3 \text{ ns}$ )

Characteristics	Symbol	Test Condition			Ta = 25°C			Ta = -40~85°C		Unit
Characteristics	Symbol	Test Condition	V <sub>CC</sub> (V)	C <sub>L</sub> (pF)	Min	Тур.	Max	Min	Max	Onit
			3.3 ± 0.3	15		7.5	11.5	1.0	13.5	ns
Propagation delay time	t <sub>pLH</sub>		5.5 ± 0.5	50		10.0	15.0	1.0	17.0	
(CK-Q)	t <sub>pHL</sub>		5.0 ± 0.5	15		4.8	7.3	1.0	8.5	115
			5.0 ± 0.5	50		6.3	9.3	1.0	10.5	
			3.3 ± 0.3	15		6.3	10.1	1.0	12.0	
Propagation delay time	t <sub>pHL</sub>	_	$5.5 \pm 0.5$	50		8.8	13.6	1.0	15.5	ns
( CLR -Q)			$5.0\pm0.5$	15		4.3	6.4	1.0	7.5	113
				50		5.8	8.4	1.0	9.5	
	f <sub>max</sub>	_	$3.3\pm0.3$	15	90	140	_	75	—	
Maximum clock frequency			0.0 ± 0.0	50	50	75		45	_	МН≠
Maximum clock nequency			$5.0 \pm 0.5$	15	150	210		125	_	MHz
				50	85	115		75	_	
Output to output skew	t <sub>osLH</sub>	(Note1)	$\textbf{3.3}\pm\textbf{0.3}$	50		_	1.5		1.5	ns
	t <sub>osHL</sub>	(NOLET)	$5.0\pm0.5$	50			1.0		1.0	19
Input capacitance	C <sub>IN</sub>		_			4	10		10	pF
Power dissipation capacitance	C <sub>PD</sub>			(Note2)		44		_	_	pF

Note1: Parameter guaranteed by design.

 $t_{OSLH} = |t_{pLHm} - t_{pLHn}|, t_{OSHL} = |t_{pHLm} - t_{pHLn}|$ 

Note2: C<sub>PD</sub> is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

Average operating current can be obtained by the equation:

 $I_{CC (opr)} = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}/4$  (per bit)

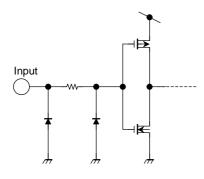
And the total CPD when n pcs of flip-flop operate can be gained by the following equation:

C<sub>PD</sub> (total) = 30 + 14 · n

Noise Characteristics (Input:  $t_r = t_f = 3 \text{ ns}$ )

Characteristics	Symbol	Test Condition	_	Ta = 25°C		- Unit
	Symbol		$V_{CC}(V)$	Тур.	Limit	Onit
Quiet output maximum dynamic $V_{OL}$	V <sub>OLP</sub>	C <sub>L</sub> = 50 pF	5.0	0.4	0.8	V
Quiet output minimum dynamic $V_{OL}$	V <sub>OLV</sub>	C <sub>L</sub> = 50 pF	5.0	-0.4	-0.8	V
Minimum high level dynamic input voltage $V_{IH}$	V <sub>IHD</sub>	C <sub>L</sub> = 50 pF	5.0	_	3.5	V
Maximum low level dynamic input voltage $V_{\rm IL}$	V <sub>ILD</sub>	C <sub>L</sub> = 50 pF	5.0		1.5	V

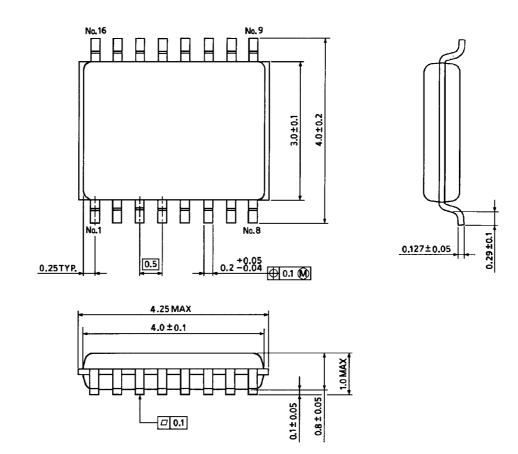
## Input Equivalent Circuit



## **Package Dimensions**

VSSOP16-P-0030-0.50

Unit : mm



Weight: 0.02 g (typ.)

#### **RESTRICTIONS ON PRODUCT USE**

Handbook" etc..

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